

ENTERPRISE D-SERIES

PCIe Gen5 Data Center Storage Solution in E1.S Form Factor

PASCARI D200

Sequential Read

Up to 14,000 MB/s

Sequential Write

Up to 8,500 MB/s

Random Read

Up to 3,300K IOPS

Random Write

Up to 880K IOPS

Interface

PCle 5.0 x4

Capacity

Up to 7.68TB

Form Factor

E1.S

DWPD

1,3

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Product Features

- NVMe 2.0
- 128 Namespaces
- Power Loss Protection (PLP)
- ISE, TCG Opal 2.0 support
- AES-XTS 256-bit Encryption
- Data Integrity and Protection
- End-to-End Data Path Protection
- SECDED
- Sanitize
- NVMe-MI (Management Interface)
- SMBus



Solution - D200E

| Form Factor E1.S | | | | | | |
|--------------------------------|--|--|--|--|--|--|
| Capacity ⁽¹⁾ | 1.6TB | 3.2TB | 6.4TB | | | |
| Interface | PCIe 5.0 x4 | PCIe 5.0 x4 | PCIe 5.0 x4 | | | |
| NVMe | 2.0 | 2.0 | 2.0 | | | |
| NAND Flash | 3D TLC | 3D TLC | 3D TLC | | | |
| Performance ^(2,3,4) | | | | | | |
| Sequential Read (MB/s) | 14,000 | 14,000 | 14,000 | | | |
| Sequential Write (MB/s) | 4,200 | 8,400 | 8,500 | | | |
| 4K Random Read (IOPS) | 2,350K | 3,300K | 3,200K | | | |
| 4K Random Write (IOPS) | 390K | 670K | 880K | | | |
| Read Latency (Typ., µs) | 60 | 60 | 60 | | | |
| Write Latency (Typ., µs) | 9 | 9 | 9 | | | |
| Power Consumption (5) | | | | | | |
| Active (W) | 17 | 20 | 22 | | | |
| Idle (W) | 4.9 | 4.9 | 4.9 | | | |
| Endurance/Reliability | | | | | | |
| DWPD ⁽⁶⁾ | 3 | 3 | 3 | | | |
| UBER | < 1 sector per 10 ¹⁸ bits read | < 1 sector per 10 ¹⁸ bits read | < 1 sector per 10 ¹⁸ bits read | | | |
| MTBF (million hours) | 2.5 | 2.5 | 2.5 | | | |
| Limited Warranty (years) | 5 | 5 | 5 | | | |
| | Temperature | | | | | |
| Operating Temp. (°C) | 0 - 70 | 0 - 70 | 0 - 70 | | | |
| Non-Operating Temp. (°C) | -40 - 85 | -40 - 85 | -40 - 85 | | | |
| Physical Dimension | | | | | | |
| Length (mm) | 118.75 | 118.75 | 118.75 | | | |
| Width (mm) | 33.75 | 33.75 | 33.75 | | | |
| Height (mm) | 9.5 | 9.5 | 15 | | | |
| Weight (g) | <80 | <80 | <100 | | | |
| Part Number | | | | | | |
| ISE FW | DP20AH021T60E312 T0410 | DP20AH023T20E314 T0910 | DP20BH026T40E318 T1910 | | | |
| SED FW | DP20AH021T60E212 T0410 | DP20AH023T20E214 T0910 | DP20BH026T40E218 T1910 | | | |



The data within this specification is subject to change by Phison without notice. Performance numbers may vary based on system configuration and testing conditions. Copyright @ 2025 Phison Electronics. All rights reserved.

^{(1) 1} TB = 10¹² bytes.
(2) Sequential Performance is based on FIO on Linux, 512KB data size, with QD=32, 1 job.
(3) Random Performance is based on FIO on Linux, 4KB data size, QD=128, 8 jobs.
(4) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 job.
(5) Power consumption (average RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).
(6) The results of DWPD are obtained in compliance with JESD219A standards.

Solution - D200P

| Form Factor E1.S | | | | | | |
|--------------------------------|--|--|--|--|--|--|
| Capacity ⁽¹⁾ | 1.92TB | 3.84TB | 7.68TB | | | |
| Interface | PCIe 5.0 x4 | PCle 5.0 x4 | PCIe 5.0 x4 | | | |
| NVMe | 2.0 | 2.0 | 2.0 | | | |
| NAND Flash | 3D TLC | 3D TLC | 3D TLC | | | |
| Performance ^(2,3,4) | | | | | | |
| Sequential Read (MB/s) | 14,000 | 14,000 | 14,000 | | | |
| Sequential Write (MB/s) | 4,200 | 8,400 | 8,500 | | | |
| 4K Random Read (IOPS) | 2,350K | 3,300K | 3,200K | | | |
| 4K Random Write (IOPS) | 140K | 220K | 420K | | | |
| Read Latency (Typ., μs) | 60 | 60 | 60 | | | |
| Write Latency (Typ., µs) | 9 | 9 | 9 | | | |
| Power Consumption (5) | | | | | | |
| Active (W) | 16 | 19 | 23 | | | |
| Idle (W) | 4.9 | 4.9 | 4.9 | | | |
| Endurance/Reliability | | | | | | |
| DWPD ⁽⁶⁾ | 1 | 1 | 1 | | | |
| UBER | < 1 sector per 10 ¹⁸ bits read | < 1 sector per 10 ¹⁸ bits read | < 1 sector per 10 ¹⁸ bits read | | | |
| MTBF (million hours) | 2.5 | 2.5 | 2.5 | | | |
| Limited Warranty (years) | 5 | 5 | 5 | | | |
| | Temperature | | | | | |
| Operating Temp. (°C) | 0 - 70 | 0 - 70 | 0 - 70 | | | |
| Non-Operating Temp. (°C) | -40 - 85 | -40 - 85 | -40 - 85 | | | |
| Physical Dimension | | | | | | |
| Length (mm) | 118.75 | 118.75 | 118.75 | | | |
| Width (mm) | 33.75 | 33.75 | 33.75 | | | |
| Height (mm) | 9.5 | 9.5 | 15 | | | |
| Weight (g) | <80 | <80 | <100 | | | |
| Part Number | | | | | | |
| ISE FW | DP20AH021T92P312 T0410 | DP20AH023T84P314 T0910 | DP20BH027T68P318 T1910 | | | |
| SED FW | DP20AH021T92P212 T0410 | DP20AH023T84P214 T0910 | DP20BH027T68P218 T1910 | | | |



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(4) Latency is measured with random workloads based on FIO on Linux, 4KB data size, QD=1, 1 job.
(5) Power consumption (average RMS) is measured during the sequential read/write and random read/write operations performed by iometer with the conditions described in (2)(3).
(6) The results of DWPD are obtained in compliance with JESD219A standards.